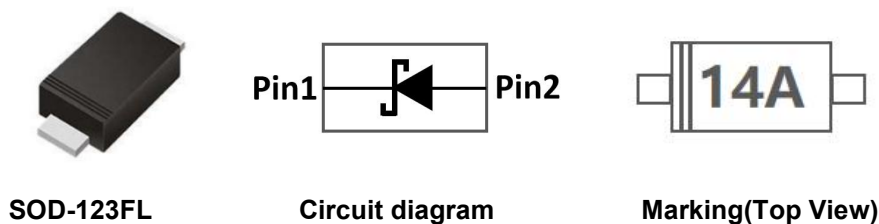


1. General Description



SOD-123FL

Circuit diagram

Marking(Top View)

2. Specification Features

- For surface mounted applications
- Built-in strain relief, ideal for automated placement
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
- 250 °C/10 seconds at terminals

3. Application

- Low voltage, high frequency inverters
- polarity protection applications

4. Maximum Ratings&Thermal Characteristics

Parameters		Symbol	Limit	Unit
Maximum repetitive peak reverse voltage		V_{RRM}	40	V
Maximum RMS voltage		V_{RMS}	28	
Maximum DC blocking voltage		V_{DC}	40	
Maximum average forward rectified current at $T_L=100^{\circ}C$		$I_{(AV)}$	1.0	A
Maximum instantaneous forward voltage at 1.0A		V_F	0.55	V
Maximum DC reverse current at rated DC blocking voltage	$T_A=25^{\circ}C$	I_R	0.5	mA
	$T_A=125^{\circ}C$		50	
Peak forward surge current 8.3 ms single half sine-wave		I_{FSM}	30	A
Thermal Resistance Junction to Ambient		$R_{\theta JA}$	85	$^{\circ}C/W$
Operating junction temperature		T_j	-50 ~ +125	$^{\circ}C$
Storage temperature range		T_{stg}	-50 ~ +150	

5. Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

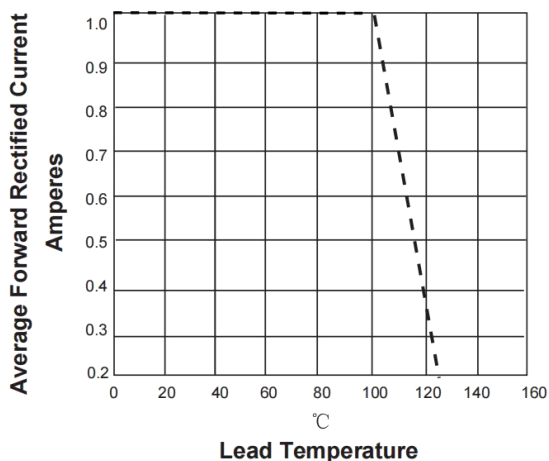


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

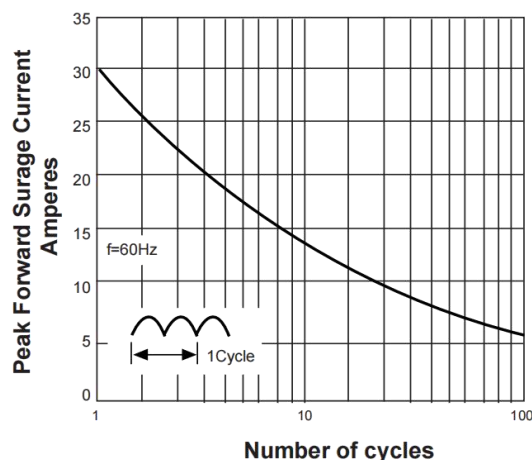


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

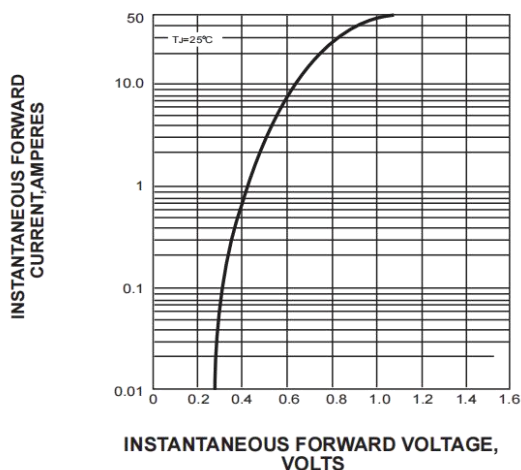
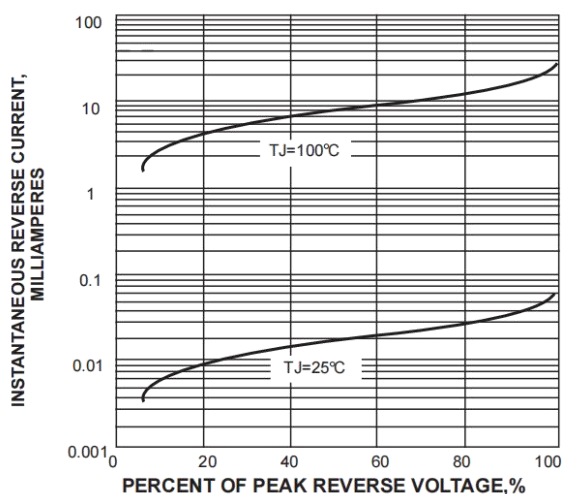
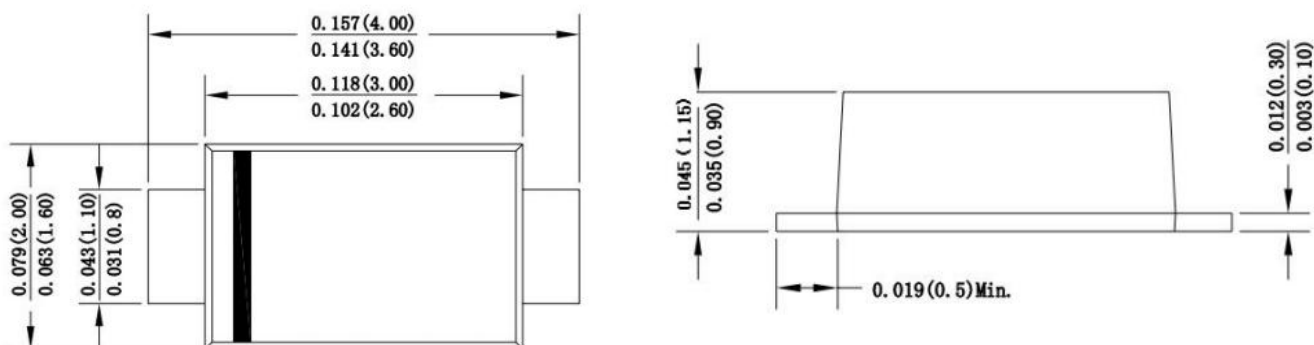


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



6. Package Outline Dimensions

Device Marking	Device	Package	Reel size	Tape width	Quantity
阴极线 14A	MS1F140	SOD-123FL	7inch	8mm	3000



7. RESTRICTIONS ON PRODUCT USE

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